	© Cop	terial Compo pyright 2005. IPC, Bannocl ternational and Pan-Americ	kburn, Illinois	. All rights reserv	tion with lower	level pa	arts, the	declaratio	on encor		ver level mate	erials for	which th	e item is an assembly ie manufacturer has leclaration.		
1/32-2 1.1		Veb Site for Informat		-1752 Standa	ird	Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa							
Supplier Information																
Company Name * Company Unique ID				Unique ID Au	Response Date *				Response Document ID							
SEMTECH CORPORATION SEMTECH CORI			RATION	N			7-08									
Contact Name * Title - Contact				Phone - Contact *			Contac	t *			<b>a</b>	A .1				
Elvia Finkel	Specialist, Document	t, Document Control/C 805-498-2111			efinkel@semtech			m Duplicate Conta			t -> Authorized Representative					
Authorized Representative * Title - Representative			9	Phone - Rep	Email - Representative *			*	Supplier Comments or URL for Additional Information							
Elvia Finkel	Specialist, Documen	t Control/C	805-498-211	efinkel@semtech.com												
Requester Item Number		Mfr Item Number		Mfr Item Name		Effective	Effective Date Version		Manufa	acturing Site	Weight *	UOI	M	Unit Type		
		GX4002-INE3		2x2 14.025Gb/s Crosspoint Swi		i			Malays	sia	72.92	mg		Each		
Alternate Recommenda	ation			Alternate Item C			e Item Co	omments								
Manufacturing Proces	s Inf	ormation														
Terminal Plating / Grid Array	Vateria	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ting F	Peak Proc	ess Body	Temper	ature Max Time	e at Peak Temp	perature 1	Number	of Reflow Cycles		
Matte Tin (Sn) - annealed CU Alloy				260			<b>260</b> C	2 30 seconds 3								
GX4002-INE3 is a REACH	l-com	npliant product, per	EU Regul	ation EC190	7/2006 to include	recent	addition	of SVH	C cand	idate list of s	ubstances D	ecembe	r 2015			

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields				
RoHS Material Composition Declaration Declaration Type *   Detailed											
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),				
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided				
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted				
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration				
Declaration S	ignature										
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars				

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

**Subltem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous		Unit of		Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
	Name		Material	weight	Measure		Level	Substance Category								-	+	
+I -I	Leadframe	+M -M	194	26.95	mg	+C -C	Supplier		+S	-S	Cu	7440-50-8		26.16	mg		!	970,76
									+S	-s	Fe	7439-89-6		0.63	mg			23,398
									+S	-s	Zn	7440-66-6		0.03	mg			1,195
									+S	-s	Р	7723-14-0		0.01	mg			301
									+S	-s	Ag	7440-22-4		0.12	mg			4,345
+  -	Mold Compound	+M -M	EME G770HCD	39.03	mg	+C -C	Supplier		+S	-S	Silica Fused	60676-86-0		35.79	mg		,	916,99
									+S	-S	Epoxy Resin	Trade Secre	2	1.56	mg			40,001
									+S	-s	Phenol Resin	Trade Secre	-	1.56	mg			40,001
									+S	-s	Carbon Black	1333-86-4		0.12	mg			3,000
+  -	Chip	+M -M		5.36	mg	+C -C	Supplier		+S	-S	Si	7440-21-3		5.33	mg		!	994,00
									+S	-S	AI	7429-90-5		0.03	mg		1	6,000
+  -	Die Attach	+M -M	CRM-1076NS	0.4	mg	+C -C	Supplier		+S	-S	Ag	7440-22-4		0.32	mg		ł	8,000,5
		_							+S	-s	Epoxy Resin	9003-36-5		0.04	mg			99,975
									+S	-s	Diluent	26447-14-3		0.02	mg			59,935
									+S	-s	Dicyandiamide	461-58-5		0	mg			10,073
									+S	-s	Hardener	620-92-8		0.01	mg			29,967
+  -	Wire	+M -M		0.07	mg	+C -C	Supplier		+S	-S	Au	7440-57-5		0.07	mg			1,000,0
+  -	Tin Plate	+M -M		1.11	mg	+C -C	Supplier		+S	-S	Sn	744-31-5		1.11	mg			1,000,0